January 2008

Do Not Use for New Designs - use PE55 or PE77

- Pletronics' PE76D/PE78D Series is a quartz crystal controlled precision square wave generator with a PECL output.
- FR4 base with a mechanical metal cover.
- Solder pad compatible with many 9x14mm plastic J lead packages.
- Has internal bypass capacitor on the Vcc lead
- Tape and Reel or cut tape packaging is available.
- 40 to 250 MHz
- 9.04mm x 8.91mm (S package)
- Enable/Disable PE76D on pad 1 PE78D on pad 2)
- Disable function includes low standby power mode
- 3rd Overtone Crystals used
- Low Jitter
- 5x7 mm LCC ceramic oscillator PE77 series

Pletronics Inc. certifies this device is in accordance with the RoHS 5/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's

Weight of the Device: 0.4 grams

Moisture Sensitivity Level: 1 As defined in J-STD-020C

Second Level Interconnect code: e4

Absolute Maximum Ratings:

Parameter	Unit
V _{cc} Supply Voltage	-0.5V to +7.0V
Vi Input Voltage	-0.5V to V _{CC} + 0.5V
Vo Output Voltage	-0.5V to V _{CC} + 0.5V

Thermal Characteristics

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 60 to 100°C/Watt depending on the solder pads, ground plane and construction of the PCB.



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Part N	lum	ber	:					
РЕ7х	45	D	Ε	W	-125.0M	-XX		Part Marking:
							Packaging code or blank T250 = 250 per Tape and Reel T500 = 500 per Tape and Reel T1K = 1000 per Tape and Reel	PLE PE77 FF.FFF M • YMDXX
							Frequency in MHz	
							Supply Voltage V _{cc} W = 2.5V ± 10%	
							Optional Enhanced OTR Blank = Temp. range -10 to +70°C E = Temp. range -40 to +85°C	
							Series Model	
							Frequency Stability 45 = ± 50 ppm 44 = ± 25 ppm 20 = ± 20 ppm	
							Series Model (where x is a 6 or 8)	

Marking Legend:

The marking is the PE77xxDW device

PLE = Pletronics

The Tape and Reel and box marking shows the PE7x PN.

FF.FFF M = Frequency in MHz

YYWW or YWW or YMD = Date of Manufacture (year and week, or year-month-day)

All other marking is internal factory codes

Specifications such as frequency stability, supply voltage and operating temperature range, etc. are not identified from the marking. External packaging labels and packing list will correctly identify the ordered Pletronics part number.

Codes for Date Code YMD

Code	6	7	8	9	0	1	2
Year	2006	2007	2008	2009	2010	2011	2012

Code		A	В	С		D	E	F	G		Н	J	K	L	M
Month	n J/	NΑ	FE	3 MA	R	APR	MAY	JUN	JUL	-	AUG	SEP	OCT	NOV	DEC
Code	1		2	3	4	4	5	6	7		8	9	Α	В	С
Day	1		2	3	4	4	5	6	7		8	9	10	11	12
Code	D		E	F	(G	Н	J	K		L	М	N	Р	R
Day	13	1	14	15	1	6	17	18	19		20	21	22	23	24
Code	T		U	٧	٧	N	Χ	Υ	Z						
Day	25	2	26	27	2	28	29	30	31						



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Electrical Specification for 2.50V ±5% over the specified temperature range

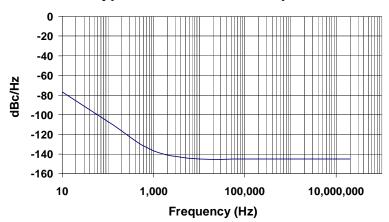
Item	Min	Max	Unit	Condition		
Frequency Range	40	250	MHz			
Frequency Accuracy "45"	-50	+50	ppm	For all supply voltages, load changes, aging for 1		
"44"	-25	-25 +25		year, shock, vibration and temperatures		
"20 "	-20	+20				
Output Waveform		PECL/E	CL			
Output High Level (0°C to 85°C)	1.475	1.760	volts	Referenced to Ground, V _{CC} = 2.5 V		
	0.975	1.260	volts	Referenced to termination voltage, V _{CC} = 2.5 V		
	-1.025	-0.740	volts	Referenced to Vcc, V _{cc} = 2.5 V		
Output High Level (-40°C)	1.415	1.620	volts	Referenced to Ground, V _{CC} = 2.5 V		
. ,	0.915	1.12	volts	Referenced to termination voltage, V _{CC} = 2.5 V		
	-1.085	-0.88	volts	Referenced to Vcc, V _{cc} = 2.5 V		
Output Low Level (0°C to 85°C)	0.690	1.095	volts	Referenced to Ground, V _{CC} = 2.5 V		
	0.190	0.595	volts	Referenced to termination voltage, V _{CC} = 2.5 V		
	-1.810	-1.405	volts	Referenced to Vcc, V _{cc} = 2.5 V		
Output Low Level (-40°C)	0.670	1.195	volts	Referenced to Ground, V _{CC} = 2.5 V		
	0.170	0.695	volts	Referenced to termination voltage, V _{CC} = 2.5 V		
	-1.830	-1.305	volts	Referenced to Vcc, V _{cc} = 2.5 V		
Output Symmetry	45	55	%	at 50% point of V _{CC} (See load circuit)		
Jitter	-	0.13	pS RMS	12 KHz to 20 MHz from the output frequency		
	-	2.8	pS RMS	10 Hz to 1 MHz from the output frequency		
Output T _{RISE} and T _{FALL}	-	0.7	nS	Vth is 20% and 80% of waveform		
V _{cc} Supply Current (I _{cc})	-	90	mA			
Enable/Disable Internal Pull-up	50	-	Kohm	to V _{cc}		
V disable	-	0.6	volts	Referenced to pad 3		
V enable	1.7	-	volts	Referenced to pad 3		
Output leakage $V_{OUT} = V_{CC}$	-10	+10	uA	Pad 1 low, device disabled		
$V_{OUT} = 0V$	-10	+10	uA			
Enable time	-	10	nS	Time for output to reach a logic state		
Disable time	-	10	nS	Time for output to reach a high Z state		
Start up time	-	10	mS	Time for output to reach specified frequency		
Operating Temperature Range	-10	+70	°C	Standard Temperature Range		
	- 40	+85	°C	Extended Temperature Range "E" Option		
Storage Temperature Range	-55	+125	°C			
Standby Current I _{CC}	-	3	uA	Pad 1 low, device disabled		

Specifications with Pad 1 E/D open circuit

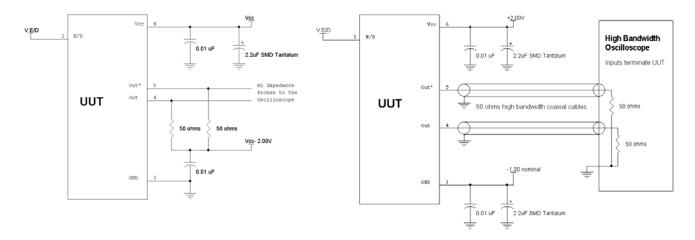


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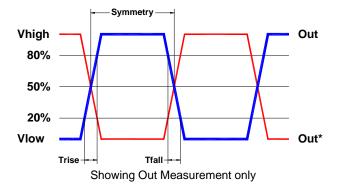
Typical Phase-Noise Response



Load Circuit



Test Waveform





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Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A

ESD Rating

Model	Minimum Voltage	Conditions		
Human Body Model	1500	MIL-STD-883 Method 3115		
Charged Device Model	1000	JESD 22-C101		

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Courier New Bar code is 39-Full ASCII (PE76 example shown)

Label is 1" \times 2.6" (25.4mm \times 66.7mm) Font is Arial

P/N: PE7645DW-100.0M

Customer P/N: 12345678

Qty: 1000 75409

RoHS Compliant

2nd LvL Interconnect

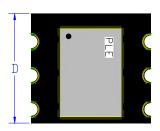
Category=e4

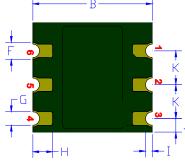
Max Safe Temp=245C for 10s 2X Max



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Mechanical:





FR4 PCB Base: Solder masked

Label: laser marked lettering

All via holes tented on bottom Copper Clad 670 μinch (17 μm) Nickel plated 118 μinch (3 μm) Gold plated 0.8 μinch (0.02 μm) Typical thicknesses

Pin 3 Ground plane is typical **Not to scale**

	Inches	mm
В	0.356 <u>+</u> 0.005	9.04 <u>+</u> 0.13
С	0.126 <u>+</u> 0.005	3.21 <u>+</u> 0.13
D	0.324 <u>+</u> 0.005	8.23 <u>+</u> 0.13
F	0.050	1.27
Ğ	0.040	1.02
H¹	0.059	1.50
I ¹	0.020	0.51
J¹	0.040	1.02
K¹	0.100	2.54
L ¹	0.062	1.57

Pa	ad	Function	Note
76	78		
1	2	Output Enable/Disable	When this pad is not connected the oscillator shall operate. When this pad is <0.30 volts, the output will be inhibited (high impedance state.) Recommend connecting this pad to $V_{\rm CC}$ if the oscillator is to be always on.
2	2 1 No connect		There is no internal connection to this pad
3	3	Ground (GND)	
4	1	Output	Both outputs must be terminated and biased for proper operation. The ideal
5 Output*		Output*	termination is 50 ohms connected to 2.0V below the Supply Voltage.
6 Supply Voltage		Supply Voltage (V _{cc})	Recommend connecting appropriate power supply bypass capacitors as close as possible.

Layout and application information

Recommend connecting Pad 1 and Pad 2 together to permit the design to accept both Enable/Disable input pad versions to be used

For Optimum Jitter Performance, Pletronics recommends:

- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.



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Mechanical (obsolete version):

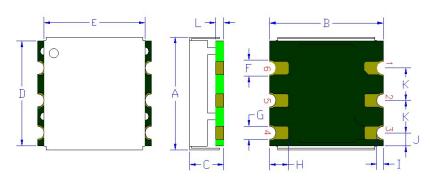
The cover is no longer being supplied over this part. This part is made with a hermetically sealed PE77xxDW series oscillator. This part is now exposed.

The cover has been deleted, the cover was causing problems with the newer high temperature RoHS lead free processes. The cover purpose was only cosmetic.

All parts with 2008 date codes will be made in the new fashion.

There is no change in electrical properties.

Pletronics does recommend that all designs should transition to the PE77xxDW ceramic part.



Cover:

Centered on the base 304 Stainless Steel 0.010 inch (0.25mm) Electroless Nickel Plated 1 µinch (25 µm) typical

Label:

White Kapton with Black Letters –or--

Blue Epoxy heat cure ink covering top with laser marked lettering

FR4 PCB Base: Solder masked

Solder masked

All via holes tented on bottom Copper Clad 670 μ inch (17 μ m) Nickel plated 118 μ inch (3 μ m) Gold plated 0.8 μ inch (0.02 μ m) Typical thicknesses

Pin 3 Ground plane is typical **Not to scale**

	Inches	mm
Α	0.351 <u>+</u> 0.003	8.91 <u>+</u> 0.07
В	0.356 <u>+</u> 0.005	9.04 <u>+</u> 0.13
С	0.103 <u>+</u> 0.005	2.62 <u>+</u> 0.13
D¹	0.324	8.23
E ¹	0.316	8.03
F ¹	0.050	1.27
G¹	0.040	1.02
H¹	0.059	1.50
I ¹	0.020	0.51
J ¹	0.040	1.02
K¹	0.100	2.54
L ¹	0.026 typical	0.66

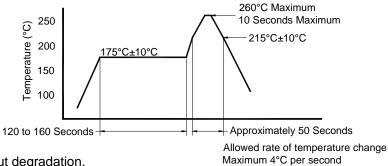


- The package is not hermetically sealed.
- The sides are intentionally left open to permit cleaning material to freely flow in the package, thus minimizing the accumulation of contaminants during cleaning processes.
- The internal part of the package must be thoroughly dry before operating.



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Reflow Cycle (typical for lead free processing)



The part may be reflowed 2 times without degradation.

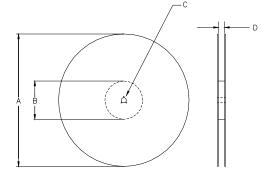
Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

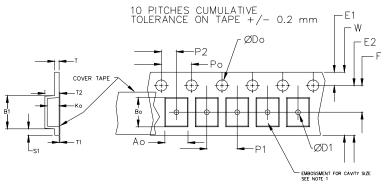
	Constant Dimensions Table 1													
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max						
8mm		1.0			2.0									
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05									
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1						
24mm		1.5			<u>+</u> 0.1									

	Variable Dimensions Table 2													
Tape Size	B1 Max	T2 Max	W Max	Ao, Bo & Ko										
24 mm	9.88	22.25	11.5 <u>+</u> 0.1	16.0 <u>+</u> 0.1	3.22	24.3	Note 1							

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm Not to scale





USER DIRECTION OF UNREELING -

		REEL DIMENSIONS			
Α	inches	7.0	10.0	13.0	
	mm	177.8	254.0	330.2	
В	inches	2.50	4.00	3.75	
	mm	63.5	101.6	95.3	Tape Width
С	mm	13.0 +0.5 / -0.2			widin
D	mm			24.4 +2.0 -0.0	24.0

Reel dimensions may vary from the above



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